Wire Ultrasonic Bonding Machine - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/3670-01-308-3702

Product Name:

Bonding machine

Special Features:

Gold wire ball bonder with bausch and lomb microscope, paired eyepiece, spotlight targeting, manual hand z operation, adj-height station heated w0rkholder with 0.1 in. Slots and one half in. Spool adapters; 900 ms cycle time; 10 to 160 grams bond force; 10 to 100 ms bond time; ultrasonic power (max) low 1.3 w and high 2.0 w; 5 in throat depth; 330 military reset to overtravel; search/loop range 0.02 in. Under reset to 0.02 above lowest overtravel; tablemotion; gross 6.5 in., fine 0.5 in. Dia.; 3.75 x 3.75 in. Bonding area; 6: 1 chessman ratio; constant tail length; 100 to 240 volts porm 10 pct; 50/60 hz, 70 va max; 26 in. H x 23.5 in. W x 26 in. D, for d9145-13494 ta-611 **Shelf Life:**

N/a

Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

A527h0